
HM5164805A Series

HM5165805A Series

8388608-word × 8-bit Dynamic Random Access Memory

HITACHI

ADE-203-458 (Z)

Preliminary

Rev. 0.3

Jan. 22, 1997

Description

The Hitachi HM5164805A Series, HM5165805A Series are CMOS dynamic RAMs organized 8,388,608-word × 8-bit. They employ the most advanced CMOS technology for high performance and low power. The HM5164805A Series, HM5165805A Series offer Extended Data Out (EDO) Page Mode as a high speed access mode. They have the package variation of standard 400-mil 32-pin plastic SOJ and standard 400-mil 32-pin plastic TSOPII.

Features

- Single 3.3 V (± 0.3 V)
- High speed
 - Access time: 50 ns/60 ns/70 ns (max)
- Low power dissipation
 - Active mode : TBD/414 mW/360 mW (max) (HM5164805A Series)
: TBD/594 mW/522 mW (max) (HM5165805A Series)
 - Standby mode : 7.2 mW (max)
: TBD (L-version)
- EDO page mode capability
- Refresh cycle
 - 8192 $\overline{\text{RAS}}$ -only refresh cycles: 64 ms (HM5164805A Series)
4096 CBR/Hidden refresh cycles: 64ms
: 128 ms (L-version)
 - 4096 $\overline{\text{RAS}}$ -only refresh cycles: 64 ms (HM5165805A Series)
4096 CBR/Hidden refresh cycles: 64ms
: 128 ms (L-version)

Preliminary: This document contains information on a new product. Specifications and information contained herein are subject to change without notice.

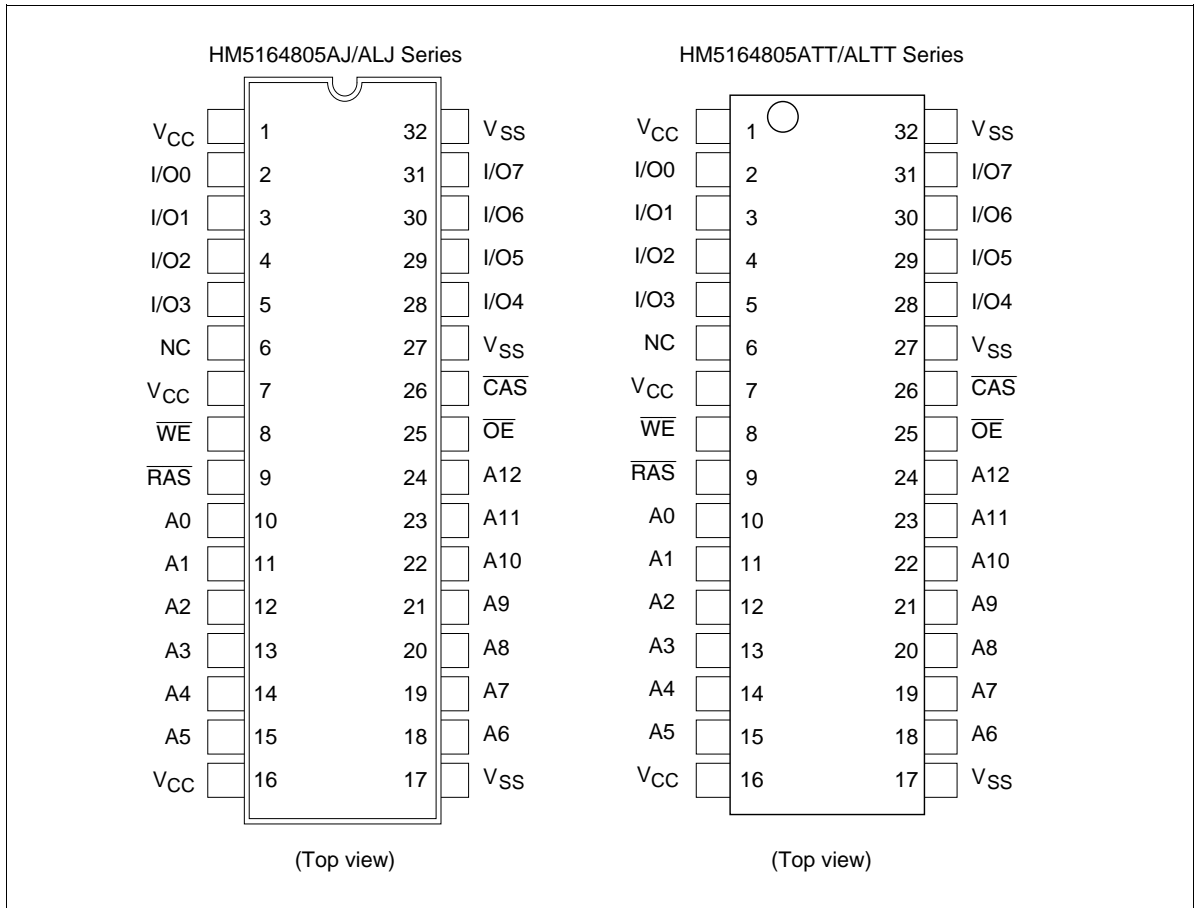
HM5164805A Series, HM5165805A Series

- 4 variations of refresh
 - $\overline{\text{RAS}}$ -only refresh
 - $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh
 - Hidden refresh
 - Self refresh (L-version)
- Battery backup operation (L-version)

Ordering Information

Type No.	Access time	Package
HM5164805AJ-5	50 ns	400-mil 32-pin plastic SOJ (CP-32DC)
HM5164805AJ-6	60 ns	
HM5164805AJ-7	70 ns	
HM5164805ALJ-5	50 ns	
HM5164805ALJ-6	60 ns	
HM5164805ALJ-7	70 ns	
HM5165805AJ-5	50 ns	
HM5165805AJ-6	60 ns	
HM5165805AJ-7	70 ns	
HM5165805ALJ-5	50 ns	
HM5165805ALJ-6	60 ns	
HM5165805ALJ-7	70 ns	
HM5164805ATT-5	50 ns	400-mil 32-pin plastic TSOP II (TTP-32DC)
HM5164805ATT-6	60 ns	
HM5164805ATT-7	70 ns	
HM5164805ALTT-5	50 ns	
HM5164805ALTT-6	60 ns	
HM5164805ALTT-7	70 ns	
HM5165805ATT-5	50 ns	
HM5165805ATT-6	60 ns	
HM5165805ATT-7	70 ns	
HM5165805ALTT-5	50 ns	
HM5165805ALTT-6	60 ns	
HM5165805ALTT-7	70 ns	

Pin Arrangement

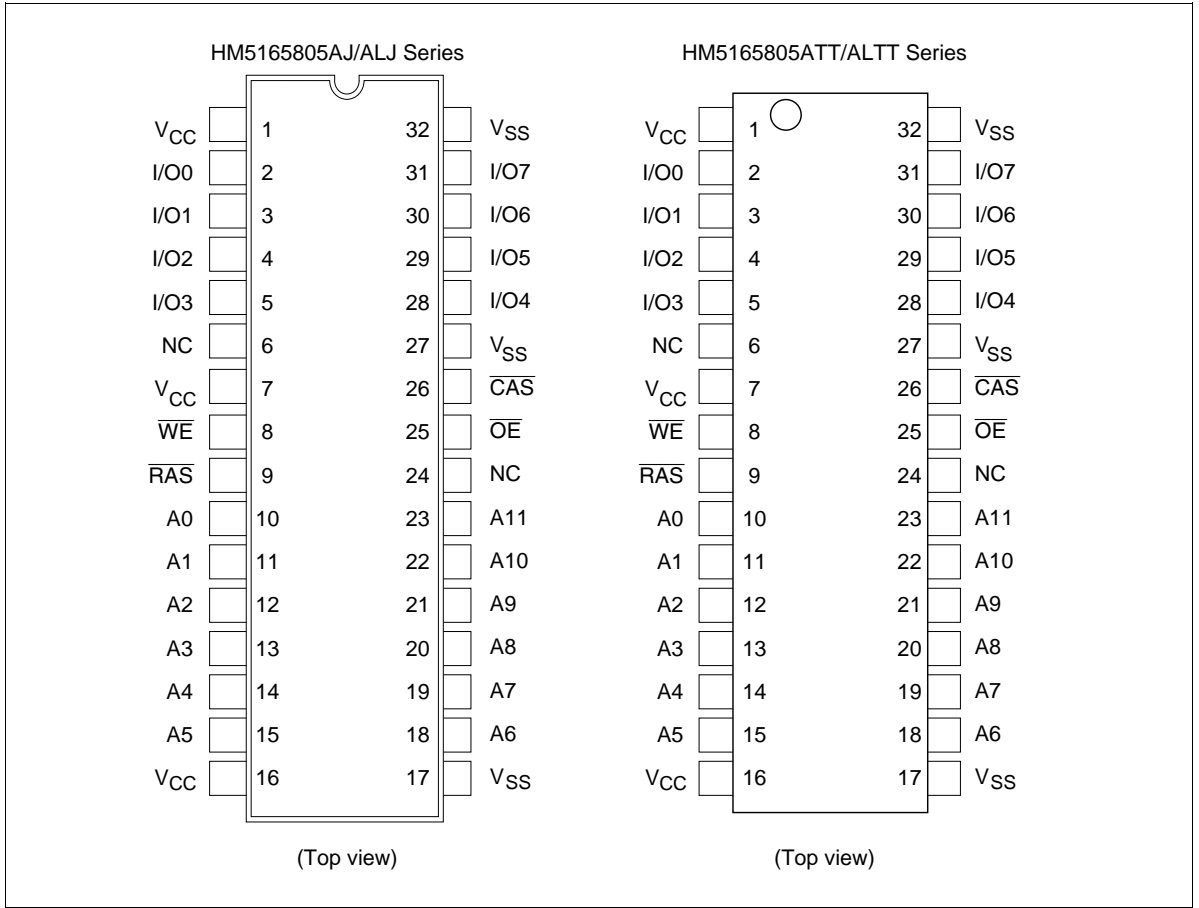


Pin Description

Pin name	Function
A0 to A12	Address input — Row/Refresh address A0 to A12 — Column address A0 to A9
I/O0 to I/O7	Data input/Data output
RAS	Row address strobe
CAS	Column address strobe
WE	Read/Write enable
OE	Output enable
V _{CC}	Power supply
V _{SS}	Ground
NC	No connection

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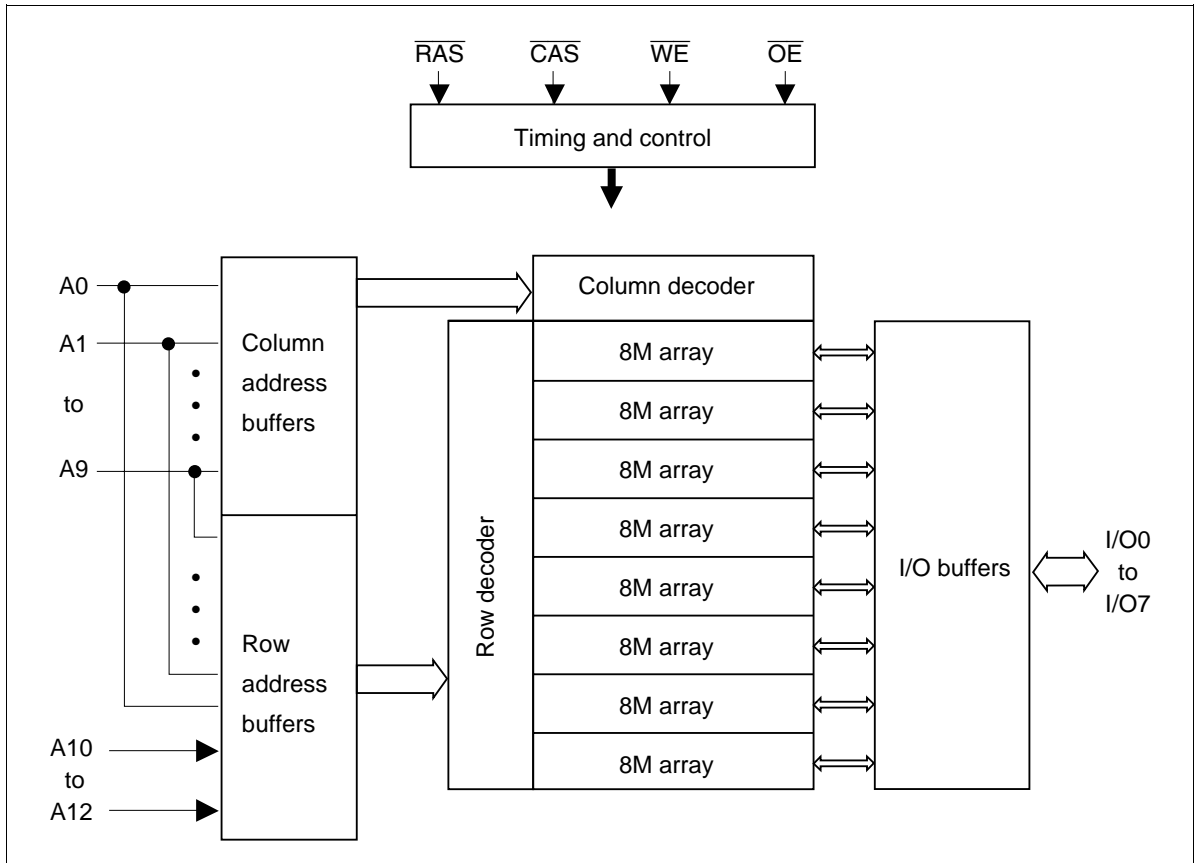
Pin Arrangement



Pin Description

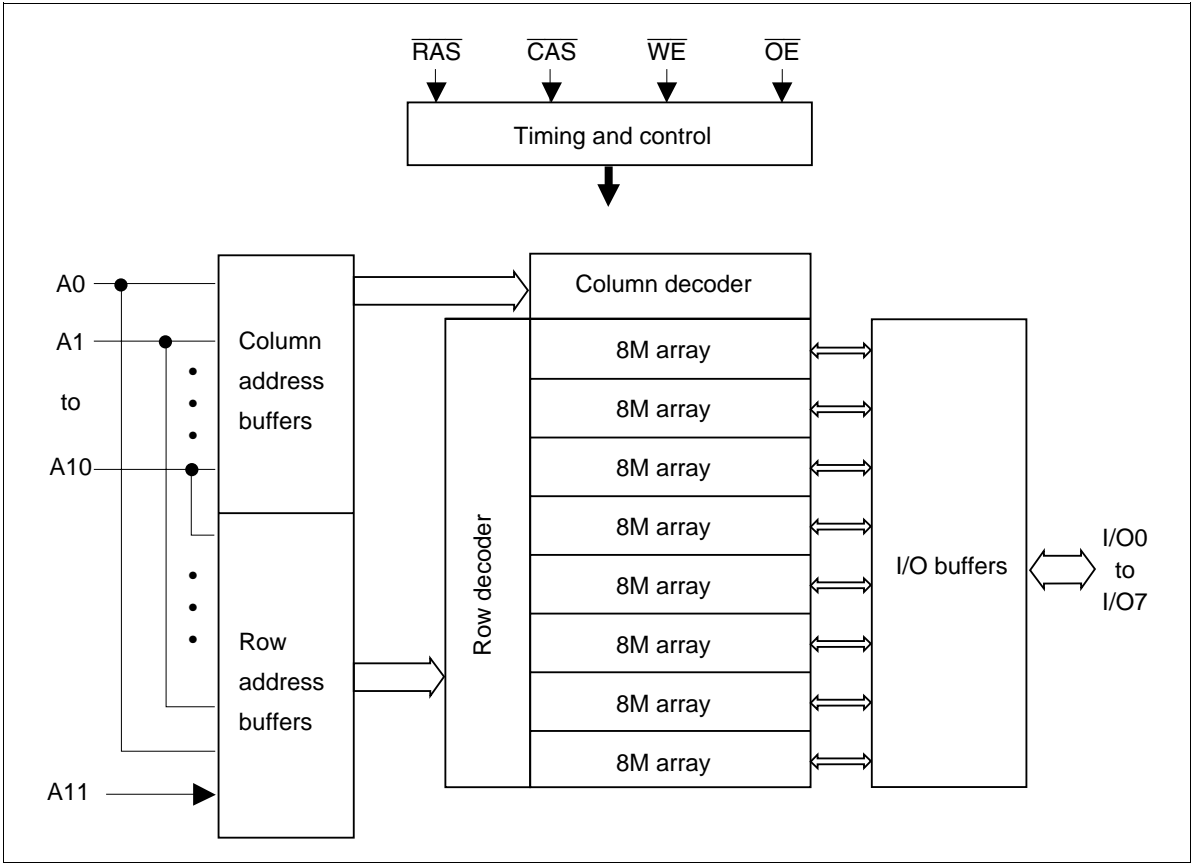
Pin name	Function
A0 to A11	Address input — Row/Refresh address A0 to A11 — Column address A0 to A10
I/O0 to I/O7	Data input/Data output
$\overline{\text{RAS}}$	Row address strobe
$\overline{\text{CAS}}$	Column address strobe
$\overline{\text{WE}}$	Read/Write enable
$\overline{\text{OE}}$	Output enable
V _{CC}	Power supply
V _{SS}	Ground
NC	No connection

Block Diagram (HM5164805A Series)



HM5164805A Series, HM5165805A Series

Block Diagram (HM5165805A Series)



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS}	V_T	-0.5 to $V_{CC} + 0.5$ (≤ 4.6 V (max))	V
Supply voltage relative to V_{SS}	V_{CC}	-0.5 to $+4.6$	V
Short circuit output current	I_{out}	50	mA
Power dissipation	P_T	1.0	W
Operating temperature	T_{opr}	0 to $+70$	$^{\circ}C$
Storage temperature	T_{stg}	-55 to $+125$	$^{\circ}C$

Recommended DC Operating Conditions ($T_a = 0$ to $+70^{\circ}C$)

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Supply voltage	V_{CC}	3.0	3.3	3.6	V	1, 2
Input high voltage	V_{IH}	2.0	—	$V_{CC} + 0.3$	V	1
Input low voltage	V_{IL}	-0.3	—	0.8	V	1

- Note:
1. All voltage referred to V_{SS} .
 2. The supply voltage with all V_{CC} pins must be on the same level. The supply voltage with all V_{SS} pins must be on the same level.

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DC Characteristics

($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{SS} = 0 \text{ V}$) (HM5164805A Series)

Parameter	Symbol	HM5164805A						Unit	Test conditions
		-5		-6		-7			
		Min	Max	Min	Max	Min	Max		
Operating current* ^{1, *2}	I_{CC1}	—	TBD	—	115	—	100	mA	$t_{RC} = \text{min}$
Standby current	I_{CC2}	—	TBD	—	2	—	2	mA	TTL interface $\overline{\text{RAS}}, \overline{\text{CAS}} = V_{IH}$ Dout = High-Z
		—	TBD	—	1	—	1	mA	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \geq V_{CC} - 0.2 \text{ V}$ Dout = High-Z
Standby current (L-version)	I_{CC2}	—	TBD	—	TBD	—	TBD	μA	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \geq V_{CC} - 0.2 \text{ V}$ Dout = High-Z
$\overline{\text{RAS}}$ -only refresh current* ²	I_{CC3}	—	TBD	—	115	—	100	mA	$t_{RC} = \text{min}$
Standby current* ¹	I_{CC5}	—	TBD	—	5	—	5	mA	$\overline{\text{RAS}} = V_{IH}$, $\overline{\text{CAS}} = V_{IL}$ Dout = enable
$\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh current	I_{CC6}	—	TBD	—	140	—	120	mA	$t_{RC} = \text{min}$
EDO page mode current* ^{1, *3}	I_{CC7}	—	TBD	—	110	—	95	mA	$t_{HPC} = \text{min}$
Battery backup current* ⁴ (Standby with CBR refresh) (L-version)	I_{CC10}	—	TBD	—	TBD	—	TBD	μA	CMOS interface Dout = High-Z, CBR refresh: $t_{RC} = 31.3 \mu\text{s}$ $t_{RAS} \leq 0.3 \mu\text{s}$
Self refresh mode current (L-version)	I_{CC11}	—	TBD	—	TBD	—	TBD	μA	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \leq 0.2 \text{ V}$ Dout = High-Z
Input leakage current	I_{LI}	TBD	TBD	-10	10	-10	10	μA	$0 \text{ V} \leq V_{in} \leq V_{CC} + 0.3$
Output leakage current	I_{LO}	TBD	TBD	-10	10	-10	10	μA	$0 \text{ V} \leq V_{in} \leq V_{CC}$ Dout = disable
Output high voltage	V_{OH}	TBD	TBD	2.4	V_{CC}	2.4	V_{CC}	V	High Iout = -2 mA
Output low voltage	V_{OL}	TBD	TBD	0	0.4	0	0.4	V	Low Iout = 2 mA

Notes : 1. I_{CC} depends on output load condition when the device is selected. I_{CC} max is specified at the output open condition.

2. Address can be changed once or less while $\overline{\text{RAS}} = V_{IL}$.

3. Address can be changed once or less within one page mode cycle t_{HPC} .

4. $V_{IH} \geq V_{CC} - 0.2 \text{ V}$, $0 \text{ V} \leq V_{IL} \leq 0.2 \text{ V}$.

DC Characteristics

($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{SS} = 0 \text{ V}$) (HM5165805A Series)

Parameter	Symbol	HM5165805A						Unit	Test conditions
		-5		-6		-7			
		Min	Max	Min	Max	Min	Max		
Operating current* ¹ , * ²	I_{CC1}	—	TBD	—	165	—	145	mA	$t_{RC} = \text{min}$
Standby current	I_{CC2}	—	TBD	—	2	—	2	mA	TTL interface $\overline{\text{RAS}}, \overline{\text{CAS}} = V_{IH}$ Dout = High-Z
		—	TBD	—	1	—	1	mA	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \geq V_{CC} - 0.2 \text{ V}$ Dout = High-Z
Standby current (L-version)	I_{CC2}	—	TBD	—	TBD	—	TBD	μA	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \geq V_{CC} - 0.2 \text{ V}$ Dout = High-Z
$\overline{\text{RAS}}$ -only refresh current* ²	I_{CC3}	—	TBD	—	165	—	145	mA	$t_{RC} = \text{min}$
Standby current* ¹	I_{CC5}	—	TBD	—	5	—	5	mA	$\overline{\text{RAS}} = V_{IH}$, $\overline{\text{CAS}} = V_{IL}$ Dout = enable
$\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh current	I_{CC6}	—	TBD	—	140	—	120	mA	$t_{RC} = \text{min}$
EDO page mode current* ¹ , * ³	I_{CC7}	—	TBD	—	125	—	110	mA	$t_{HPC} = \text{min}$
Battery backup current* ⁴ (Standby with CBR refresh) (L-version)	I_{CC10}	—	TBD	—	TBD	—	TBD	μA	CMOS interface Dout = High-Z, CBR refresh: $t_{RC} = 31.3 \mu\text{s}$ $t_{RAS} \leq 0.3 \mu\text{s}$
Self refresh mode current (L-version)	I_{CC11}	—	TBD	—	TBD	—	TBD	μA	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \leq 0.2 \text{ V}$ Dout = High-Z
Input leakage current	I_{LI}	TBD	TBD	-10	10	-10	10	μA	$0 \text{ V} \leq V_{in} \leq V_{CC} + 0.3 \text{ V}$
Output leakage current	I_{LO}	TBD	TBD	-10	10	-10	10	μA	$0 \text{ V} \leq V_{in} \leq V_{CC}$ Dout = disable
Output high voltage	V_{OH}	TBD	TBD	2.4	V_{CC}	2.4	V_{CC}	V	High Iout = -2 mA
Output low voltage	V_{OL}	TBD	TBD	0	0.4	0	0.4	V	Low Iout = 2 mA

Notes : 1. I_{CC} depends on output load condition when the device is selected. I_{CC} max is specified at the output open condition.

2. Address can be changed once or less while $\overline{\text{RAS}} = V_{IL}$.

3. Address can be changed once or less within one page mode cycle t_{HPC} .

4. $V_{IH} \geq V_{CC} - 0.2 \text{ V}$, $0 \text{ V} \leq V_{IL} \leq 0.2 \text{ V}$.

HM5164805A Series, HM5165805A Series

Capacitance ($T_a = 25^\circ\text{C}$, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$)

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	C_{I1}	—	5	pF	1
Input capacitance (Clocks)	C_{I2}	—	7	pF	1
Output capacitance (Data-in, Data-out)	$C_{I/O}$	—	7	pF	1, 2

Notes : 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.

2. $\overline{\text{RAS}}$ and $\overline{\text{CAS}} = V_{IH}$ to disable Dout.

AC Characteristics (Ta = 0 to +70°C, V_{CC} = 3.3 V ± 0.3 V, V_{SS} = 0 V) *1, *2, *3,*18

Test Conditions

- Input rise and fall time: 2 ns
- Input levels: V_{IL} = 0 V, V_{IH} = 3 V
- Input timing reference levels: 0.8 V, 2.0 V
- Output timing reference levels: 0.8 V, 2.0 V
- Output load: 1 TTL gate + C_L (100 pF) (Including scope and jig)

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

		HM5164805A/HM5165805A							
		-5		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Random read or write cycle time	t _{RC}	TBD	—	104	—	124	—	ns	
$\overline{\text{RAS}}$ precharge time	t _{RP}	TBD	—	40	—	50	—	ns	
$\overline{\text{CAS}}$ precharge time	t _{CP}	TBD	—	10	—	13	—	ns	
$\overline{\text{RAS}}$ pulse width	t _{RAS}	TBD	TBD	60	10000	70	10000	ns	
$\overline{\text{CAS}}$ pulse width	t _{CAS}	TBD	TBD	10	10000	13	10000	ns	
Row address setup time	t _{ASR}	TBD	—	0	—	0	—	ns	
Row address hold time	t _{RAH}	TBD	—	10	—	10	—	ns	
Column address setup time	t _{ASC}	TBD	—	0	—	0	—	ns	
Column address hold time	t _{CAH}	TBD	—	10	—	13	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ delay time	t _{RCD}	TBD	TBD	20	45	20	52	ns	3
$\overline{\text{RAS}}$ to column address delay time	t _{RAD}	TBD	TBD	15	30	15	35	ns	4
$\overline{\text{RAS}}$ hold time	t _{RSH}	TBD	—	15	—	18	—	ns	
$\overline{\text{CAS}}$ hold time	t _{CSH}	TBD	—	48	—	58	—	ns	21
$\overline{\text{CAS}}$ to $\overline{\text{RAS}}$ precharge time	t _{CRP}	TBD	—	5	—	5	—	ns	
$\overline{\text{OE}}$ to Din delay time	t _{OED}	TBD	—	15	—	18	—	ns	5
$\overline{\text{OE}}$ delay time from Din	t _{DZO}	TBD	—	0	—	0	—	ns	6
$\overline{\text{CAS}}$ delay time from Din	t _{DZC}	TBD	—	0	—	0	—	ns	6
Transition time (rise and fall)	t _T	TBD	TBD	2	50	2	50	ns	7

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Read Cycle

Parameter	Symbol	HM5164805A/HM5165805A						Unit	Notes
		-5		-6		-7			
		Min	Max	Min	Max	Min	Max		
Access time from $\overline{\text{RAS}}$	t_{RAC}	—	TBD	—	60	—	70	ns	8, 9
Access time from $\overline{\text{CAS}}$	t_{CAC}	—	TBD	—	15	—	18	ns	9, 10, 16
Access time from address	t_{AA}	—	TBD	—	30	—	35	ns	9, 11, 16
Access time from $\overline{\text{OE}}$	t_{OEA}	—	TBD	—	15	—	18	ns	9
Read command setup time	t_{RCS}	TBD	—	0	—	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	t_{RCH}	TBD	—	0	—	0	—	ns	12
Read command hold time from $\overline{\text{RAS}}$	t_{RCHR}	TBD	—	60	—	70	—	ns	
Read command hold time to $\overline{\text{RAS}}$	t_{RRH}	TBD	—	0	—	0	—	ns	12
Column address to $\overline{\text{RAS}}$ lead time	t_{RAL}	TBD	—	30	—	35	—	ns	
Column address to $\overline{\text{CAS}}$ lead time	t_{CAL}	TBD	—	18	—	23	—	ns	
$\overline{\text{CAS}}$ to output in low-Z	t_{CLZ}	TBD	—	0	—	0	—	ns	
Output data hold time	t_{OH}	TBD	—	3	—	3	—	ns	
Output data hold time from $\overline{\text{OE}}$	t_{OHO}	TBD	—	3	—	3	—	ns	
Output buffer turn-off time	t_{OFF}	—	TBD	—	15	—	15	ns	13, 20
Output buffer turn-off to $\overline{\text{OE}}$	t_{OEZ}	—	TBD	—	15	—	15	ns	13
$\overline{\text{CAS}}$ to Din delay time	t_{CDD}	TBD	—	15	—	18	—	ns	5
Output data hold time from $\overline{\text{RAS}}$	t_{OHR}	TBD	—	3	—	3	—	ns	
Output buffer turn-off to $\overline{\text{RAS}}$	t_{OFR}	—	TBD	—	15	—	15	ns	20
Output buffer turn-off to $\overline{\text{WE}}$	t_{WEZ}	—	TBD	—	15	—	15	ns	
$\overline{\text{WE}}$ to Din delay time	t_{WED}	TBD	—	15	—	18	—	ns	
$\overline{\text{RAS}}$ to Din delay time	t_{RDD}	TBD	—	15	—	18	—	ns	

Write Cycle

		HM5164805A/HM5165805A							
		-5		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write command setup time	t_{WCS}	TBD	—	0	—	0	—	ns	14
Write command hold time	t_{WCH}	TBD	—	10	—	13	—	ns	
Write command pulse width	t_{WP}	TBD	—	10	—	10	—	ns	
Write command to \overline{RAS} lead time	t_{RWL}	TBD	—	10	—	13	—	ns	
Write command to \overline{CAS} lead time	t_{CWL}	TBD	—	10	—	13	—	ns	
Data-in setup time	t_{DS}	TBD	—	0	—	0	—	ns	
Data-in hold time	t_{DH}	TBD	—	10	—	13	—	ns	

Read-Modify-Write Cycle

		HM5164805A/HM5165805A							
		-5		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Read-modify-write cycle time	t_{RWC}	TBD	—	149	—	175	—	ns	
\overline{RAS} to \overline{WE} delay time	t_{RWD}	TBD	—	78	—	91	—	ns	14
\overline{CAS} to \overline{WE} delay time	t_{CWD}	TBD	—	33	—	39	—	ns	14
Column address to \overline{WE} delay time	t_{AWD}	TBD	—	48	—	56	—	ns	14
\overline{OE} hold time from \overline{WE}	t_{OEH}	TBD	—	15	—	18	—	ns	

Refresh Cycle

		HM5164805A/HM5165805A							
		-5		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
\overline{CAS} setup time (CBR refresh cycle)	t_{CSR}	TBD	—	5	—	5	—	ns	
\overline{CAS} hold time (CBR refresh cycle)	t_{CHR}	TBD	—	10	—	10	—	ns	
\overline{WE} setup time (CBR refresh cycle)	t_{WRP}	TBD	—	0	—	0	—	ns	
\overline{WE} hold time (CBR refresh cycle)	t_{WRH}	TBD	—	10	—	10	—	ns	
\overline{RAS} precharge to \overline{CAS} hold time	t_{RPC}	TBD	—	0	—	0	—	ns	

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EDO Page Mode Cycle

Parameter	Symbol	HM5164805A/HM5165805A						Unit	Notes
		-5		-6		-7			
		Min	Max	Min	Max	Min	Max		
EDO page mode cycle time	t_{HPC}	TBD	—	25	—	30	—	ns	19
EDO page mode \overline{RAS} pulse width	t_{RASP}	—	TBD	—	100000	—	100000	ns	15
Access time from \overline{CAS} precharge	t_{CPA}	—	TBD	—	35	—	40	ns	9, 16
\overline{RAS} hold time from \overline{CAS} precharge	t_{CPRH}	TBD	—	35	—	40	—	ns	
Output data hold time from \overline{CAS} low	t_{DOH}	TBD	—	3	—	3	—	ns	9, 16
\overline{CAS} hold time referred \overline{OE}	t_{COL}	TBD	—	10	—	13	—	ns	
\overline{CAS} to \overline{OE} setup time	t_{COP}	TBD	—	10	—	10	—	ns	
Read command hold time from \overline{CAS} precharge	t_{RCHC}	TBD	—	35	—	40	—	ns	
Write pulse width during \overline{CAS} precharge	t_{WPE}	TBD	—	10	—	10	—	ns	
\overline{OE} precharge time	t_{OEP}	TBD	—	10	—	10	—	ns	

EDO Page Mode Read-Modify-Write Cycle

Parameter	Symbol	HM5164805A/HM5165805A						Unit	Notes
		-5		-6		-7			
		Min	Max	Min	Max	Min	Max		
EDO page mode read- modify-write cycle time	t_{HPRWC}	TBD	—	68	—	79	—	ns	
\overline{WE} delay time from \overline{CAS} precharge	t_{CPW}	TBD	—	54	—	62	—	ns	14

Refresh (HM5164805A Series)

Parameter	Symbol	Max	Unit	Notes
Refresh period	t_{REF}	64	ms	8192 cycles
Refresh period (L-version)	t_{REF}	128	ms	4096 cycles

Refresh (HM5165805A Series)

Parameter	Symbol	Max	Unit	Notes
Refresh period	t_{REF}	64	ms	4096 cycles
Refresh period (L-version)	t_{REF}	128	ms	4096 cycles

Self Refresh Mode (L-version)

Parameter	Symbol	HM5164805AL/HM5165805AL						Unit	Notes
		-5		-6		-7			
		Min	Max	Min	Max	Min	Max		
$\overline{\text{RAS}}$ pulse width (self refresh)	t_{RASS}	TBD	—	100	—	100	—	μs	
$\overline{\text{RAS}}$ precharge time (self refresh)	t_{RPS}	TBD	—	110	—	130	—	ns	
$\overline{\text{CAS}}$ hold time (self refresh)	t_{CHS}	TBD	—	-50	—	-50	—	ns	

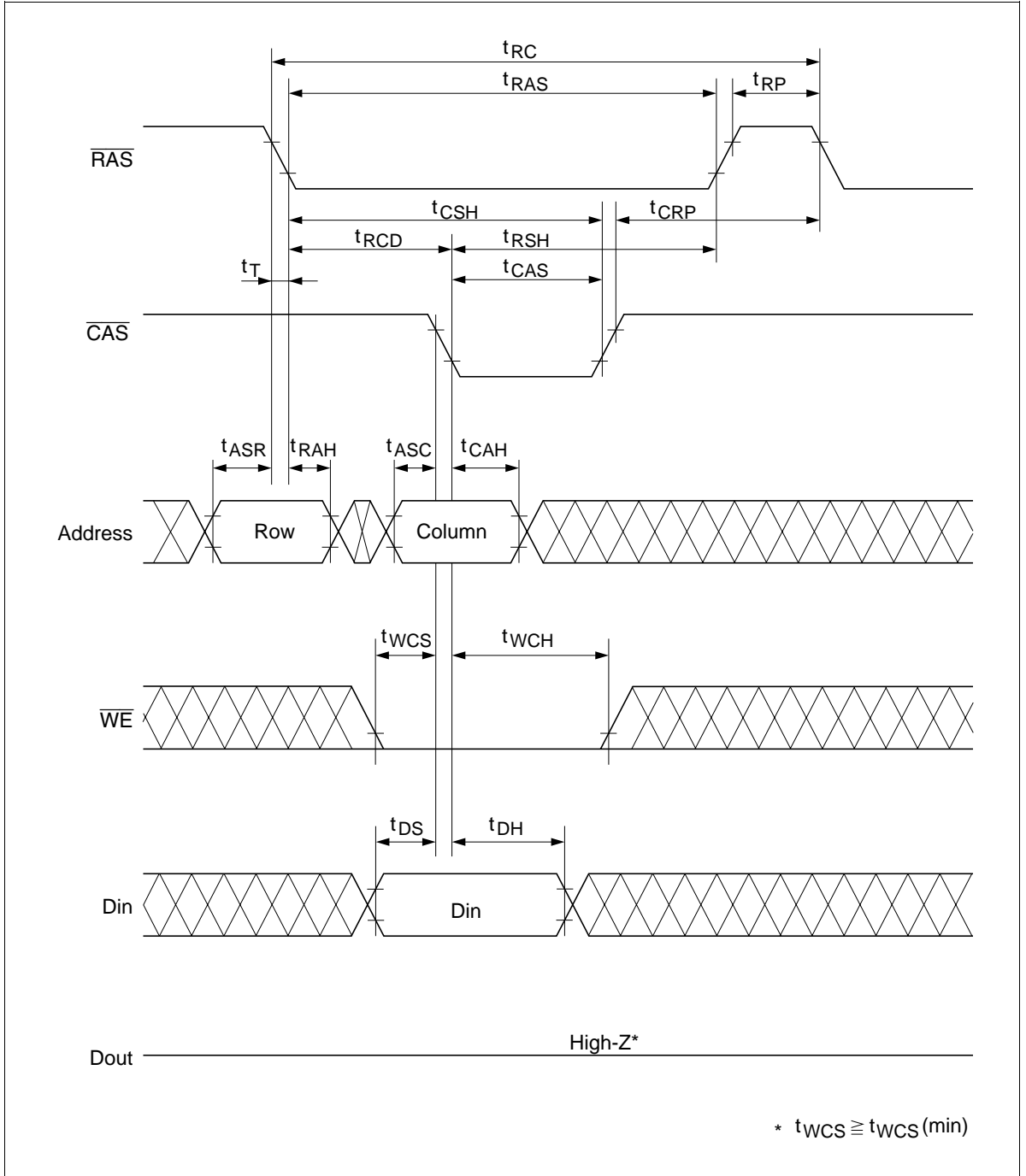
Notes: 1. AC measurements assume $t_r = 2 \text{ ns}$.

2. An initial pause of $200 \mu\text{s}$ is required after power up followed by a minimum of eight initialization cycles (any combination of cycles containing $\overline{\text{RAS}}$ -only refresh or $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh).
3. Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only; if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC} .
4. Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only; if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA} .
5. Either t_{OED} or t_{CDD} must be satisfied.
6. Either t_{DZO} or t_{DZC} must be satisfied.
7. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} (min) and V_{IL} (max).
8. Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \leq t_{\text{RAD}}$ (max). If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
9. Measured with a load circuit equivalent to 1 TTL loads and 100 pF .
10. Assumes that $t_{\text{RCD}} \geq t_{\text{RCD}}$ (max) and $t_{\text{RCD}} + t_{\text{CAC}}$ (max) $\geq t_{\text{RAD}} + t_{\text{AA}}$ (max).
11. Assumes that $t_{\text{RAD}} \geq t_{\text{RAD}}$ (max) and $t_{\text{RCD}} + t_{\text{CAC}}$ (max) $\leq t_{\text{RAD}} + t_{\text{AA}}$ (max).
12. Either t_{RCH} or t_{RRH} must be satisfied for a read cycles.
13. t_{OFF} (max), t_{OEZ} (max), t_{WEZ} (max) and t_{OFR} (max) define the time at which the outputs achieve the open circuit condition and are not referred to output voltage levels.
14. t_{WCS} , t_{RWD} , t_{CWD} , t_{AWD} and t_{CPW} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if $t_{\text{WCS}} \geq t_{\text{WCS}}$ (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{\text{RWD}} \geq t_{\text{RWD}}$ (min), $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), and $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min), or $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min) and $t_{\text{CPW}} \geq t_{\text{CPW}}$ (min), the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
15. t_{RASP} defines $\overline{\text{RAS}}$ pulse width in EDO page mode cycles.
16. Access time is determined by the longest among t_{AA} , t_{CAC} and t_{CPA} .
17. All the V_{CC} and V_{SS} pins shall be supplied with the same voltages.
18. In delayed write or read-modify-write cycles, $\overline{\text{OE}}$ must disable output buffer prior to applying data to the device.
19. t_{HPC} (min) can be achieved during a series of EDO page mode write cycles or EDO page mode read cycles. If both write and read operation are mixed in a EDO page mode $\overline{\text{RAS}}$ cycle (EDO page mode mix cycle (1), (2)), minimum value of $\overline{\text{CAS}}$ cycle ($t_{\text{CAS}} + t_{\text{CP}} + 2 t_r$) becomes greater than the specified t_{HPC} (min) value. The value of $\overline{\text{CAS}}$ cycle time of mixed EDO page mode is shown in EDO page mode mix cycle (1) and (2).

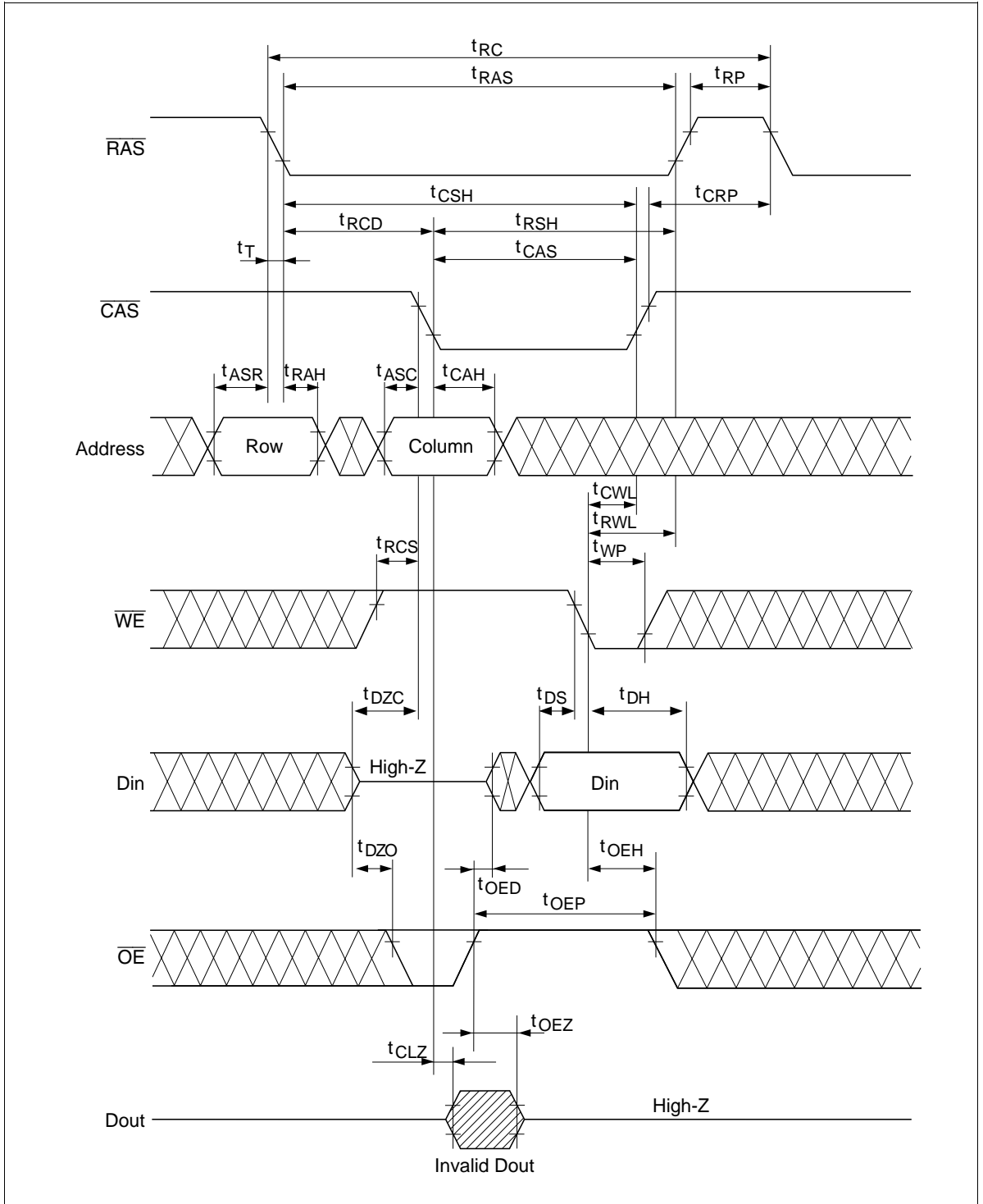
20. Data output turns off and becomes high impedance from later rising edge of $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$.
Hold time and turn off time are specified by the timing specifications of later rising edge of $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$ between t_{OHR} and t_{OH} and between t_{OFR} and t_{OFF} .
21. t_{CSH} (min) can be achieved when $t_{\text{RCD}} \leq t_{\text{CSH}}$ (min) - t_{CAS} (min).
22. Please do not use t_{RASS} timing, $10 \mu\text{s} \leq t_{\text{RASS}} \leq 100 \mu\text{s}$. During this period, the device is in transition state from normal operation mode to self refresh mode. If $t_{\text{RASS}} > 100 \mu\text{s}$, then $\overline{\text{RAS}}$ precharge time should use t_{RPS} instead of t_{RP} .
23. CBR burst refresh or 4096 cycles of distributed CBR refresh with $15.6 \mu\text{s}$ interval should be executed within 64 ms immediately after exiting from and before entering into the self refresh mode.
24. Repetitive self refresh mode without refreshing all memory is not allowed. Once you exit from self refresh mode, all memory cells need to be refreshed before re-entering the self refresh mode again.
25. XXX: H or L (H: V_{IH} (min) $\leq V_{\text{IN}} \leq V_{\text{IH}}$ (max), L: V_{IL} (min) $\leq V_{\text{IN}} \leq V_{\text{IL}}$ (max))
/////: Invalid Dout
When the address, clock and input pins are not described on timing waveforms, their pins must be applied V_{IH} or V_{IL} .

HM5164805A Series, HM5165805A Series

Early Write Cycle

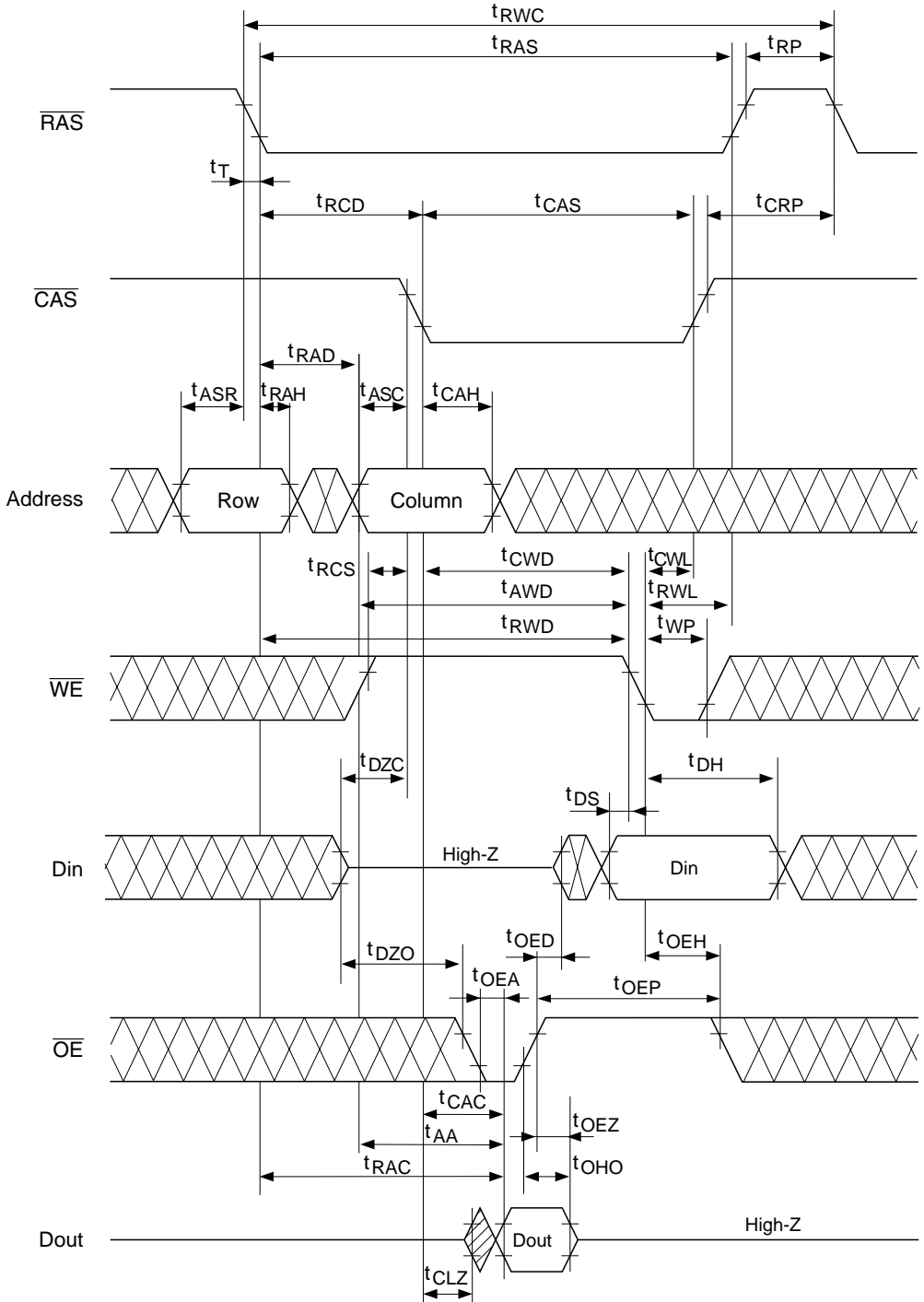


Delayed Write Cycle*18

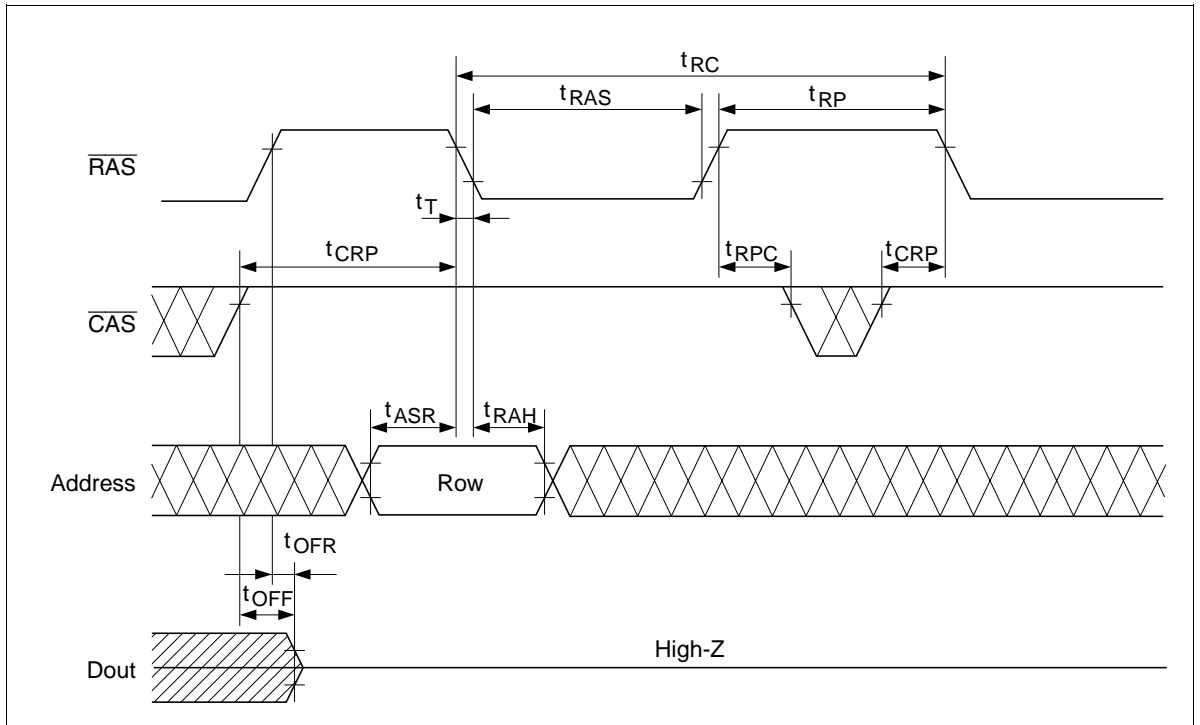


HM5164805A Series, HM5165805A Series

Read-Modify-Write Cycle*18

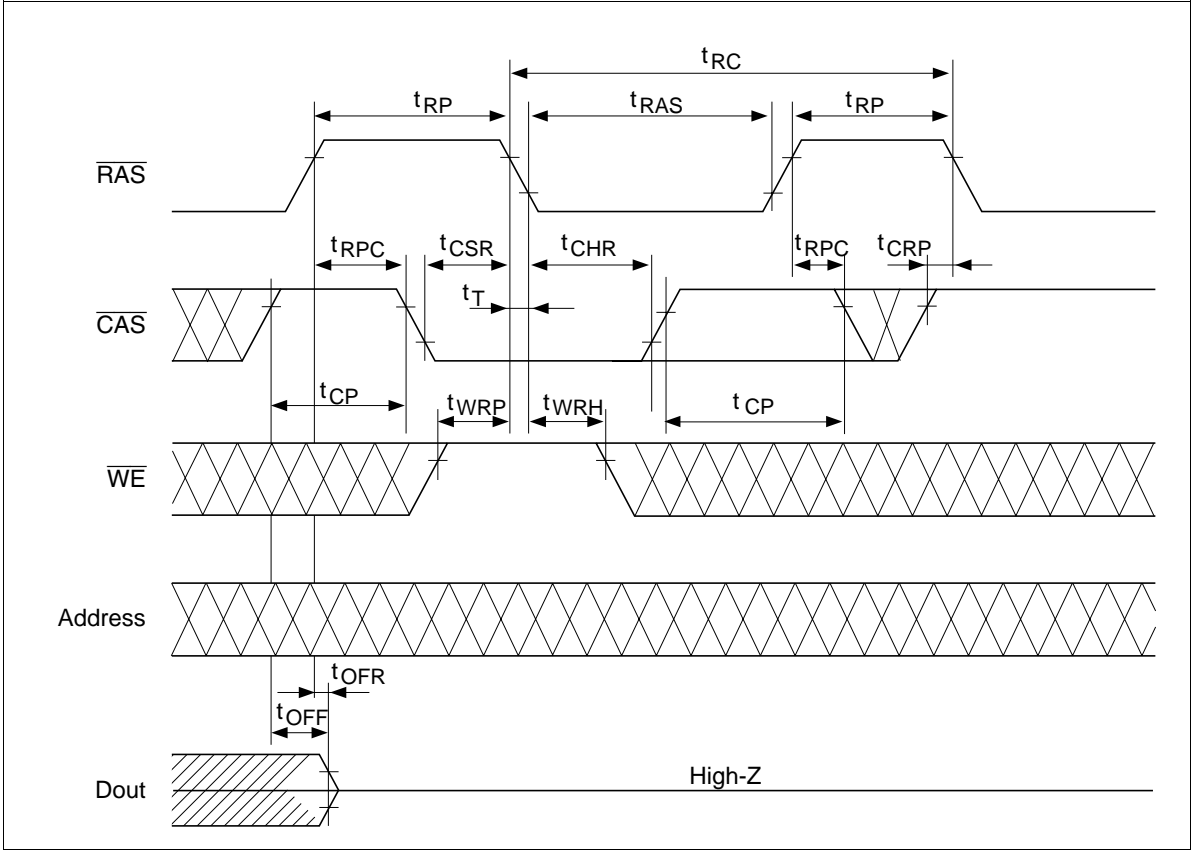


RAS-Only Refresh Cycle

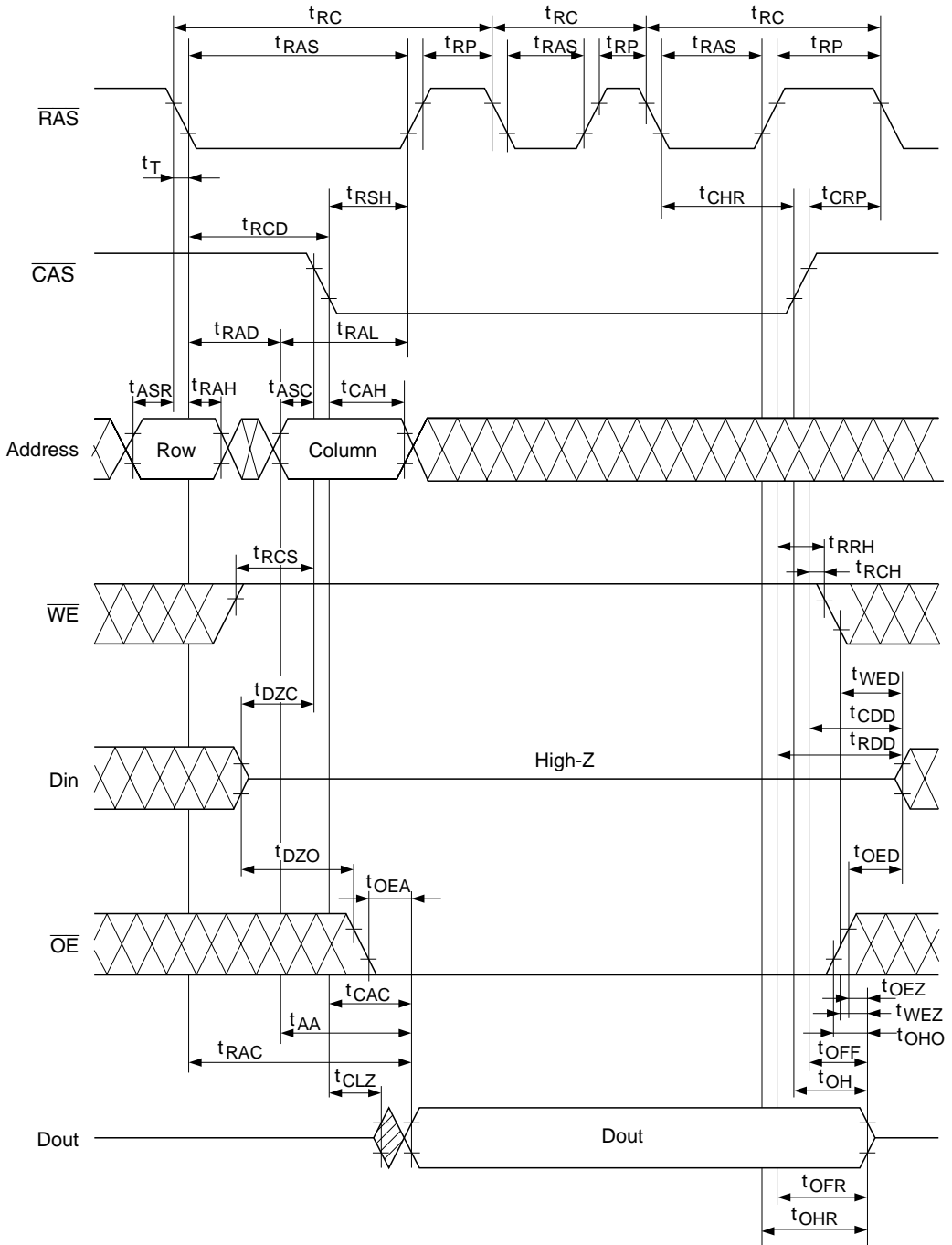


HM5164805A Series, HM5165805A Series

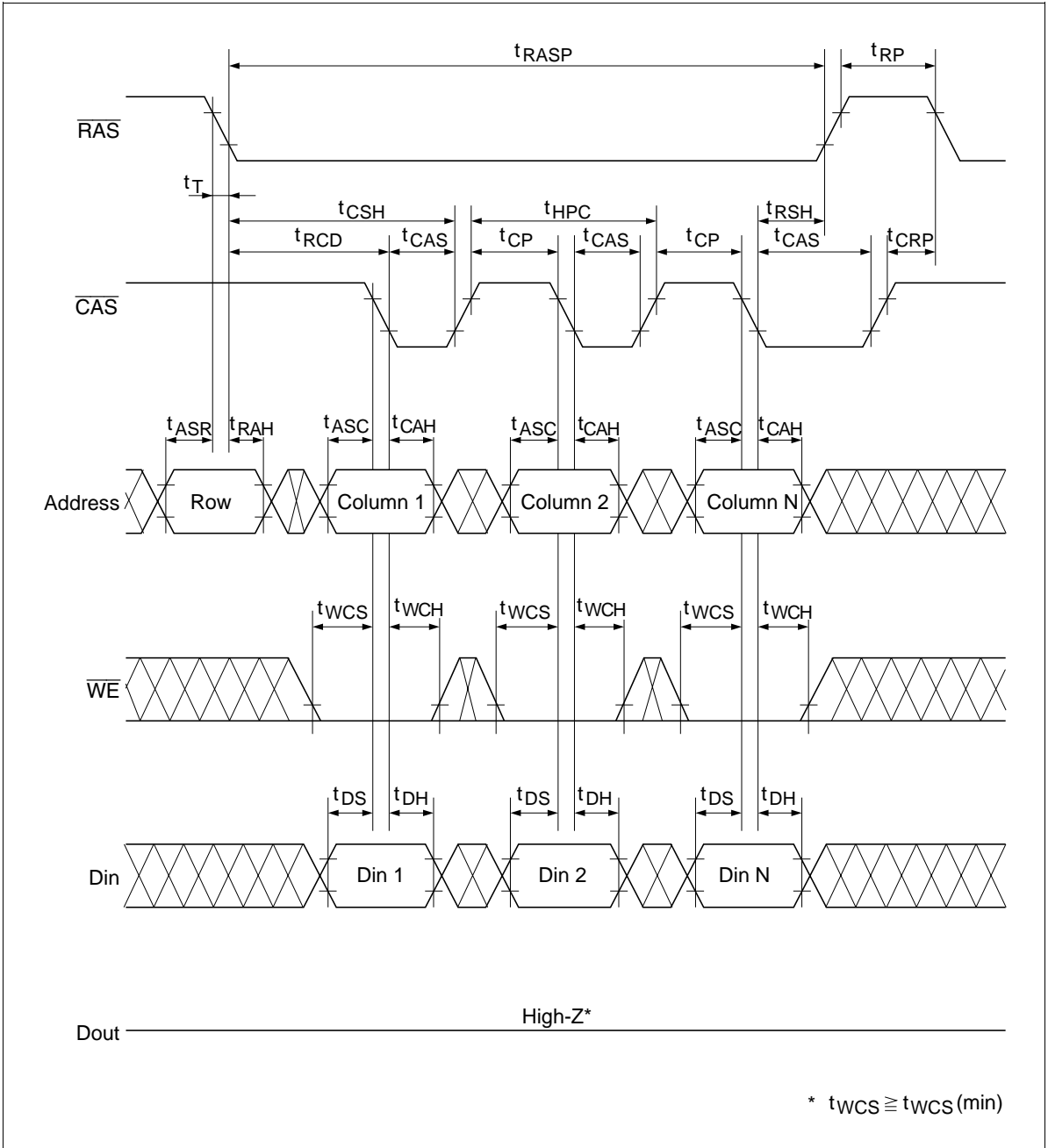
CAS-Before-RAS Refresh Cycle



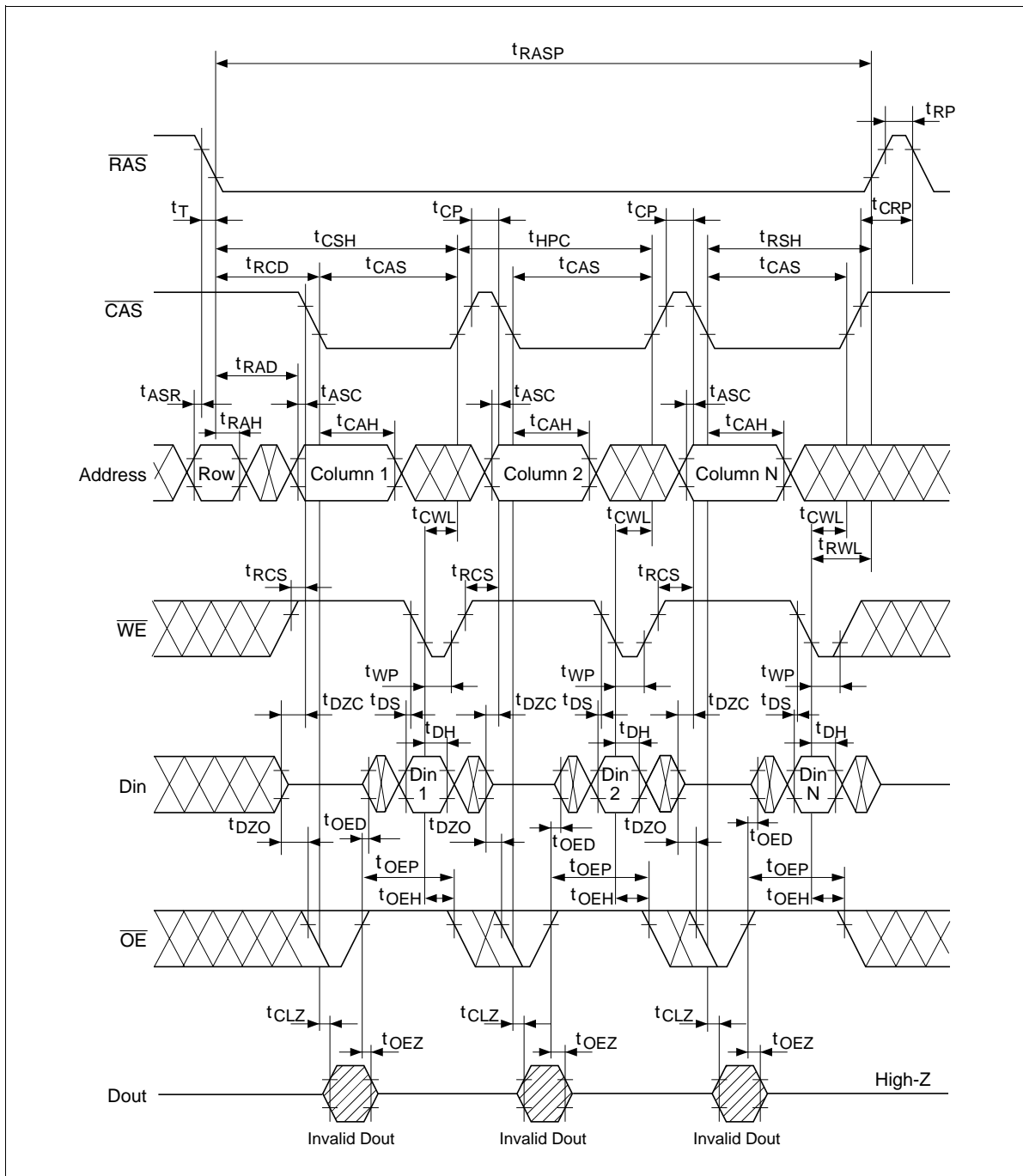
Hidden Refresh Cycle



EDO Page Mode Early Write Cycle

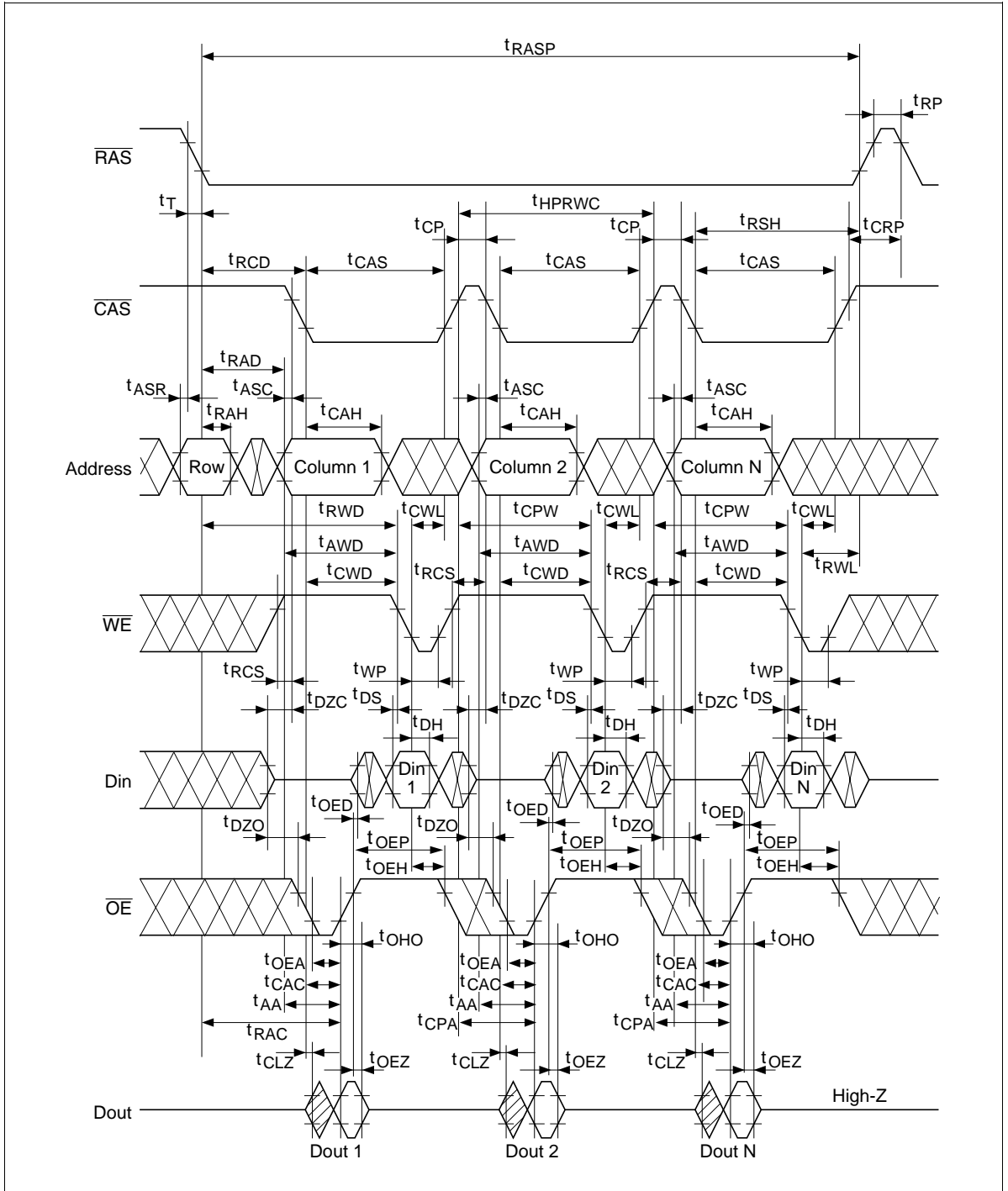


EDO Page Mode Delayed Write Cycle*18

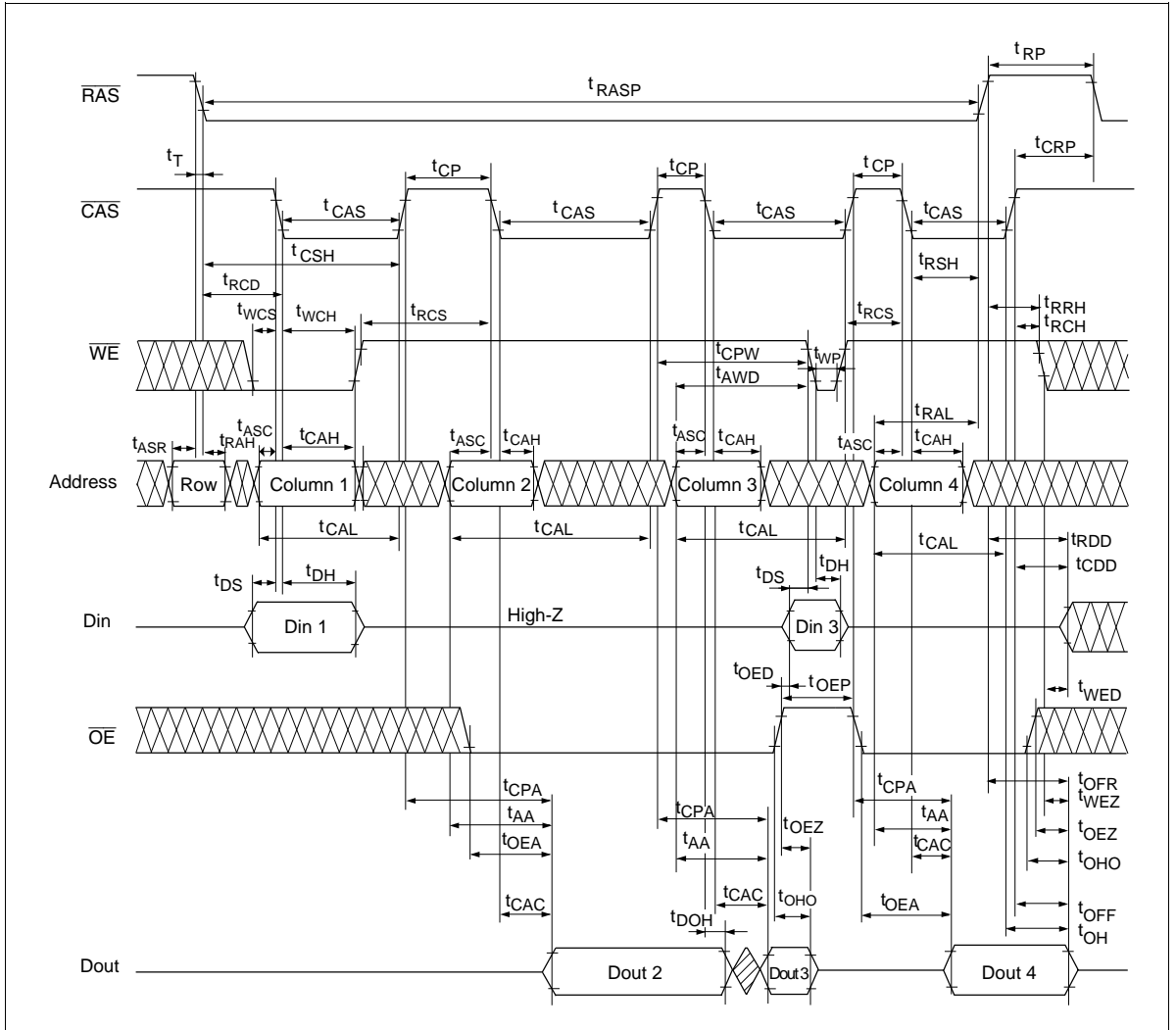


HM5164805A Series, HM5165805A Series

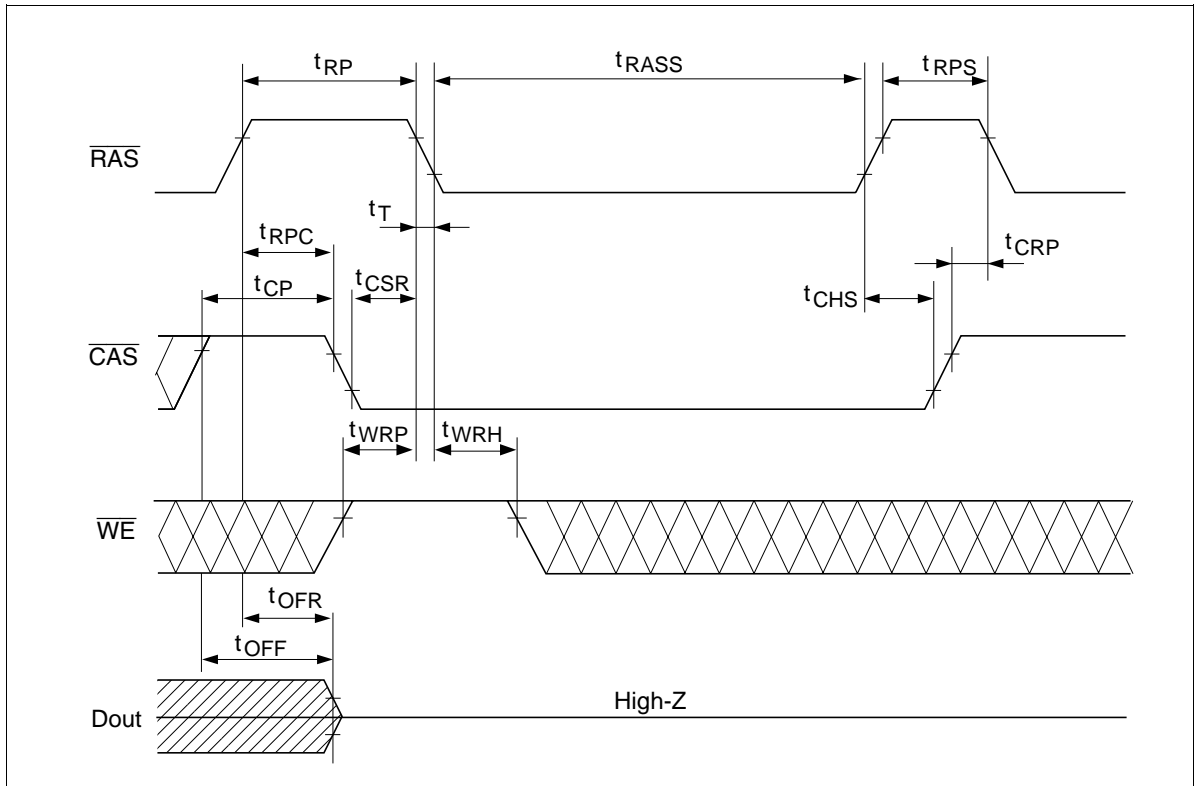
EDO Page Mode Read-Modify-Write Cycle*18



EDO Page Mode Mix Cycle (1)



Self Refresh Cycle (L-version)*22, 23, 24



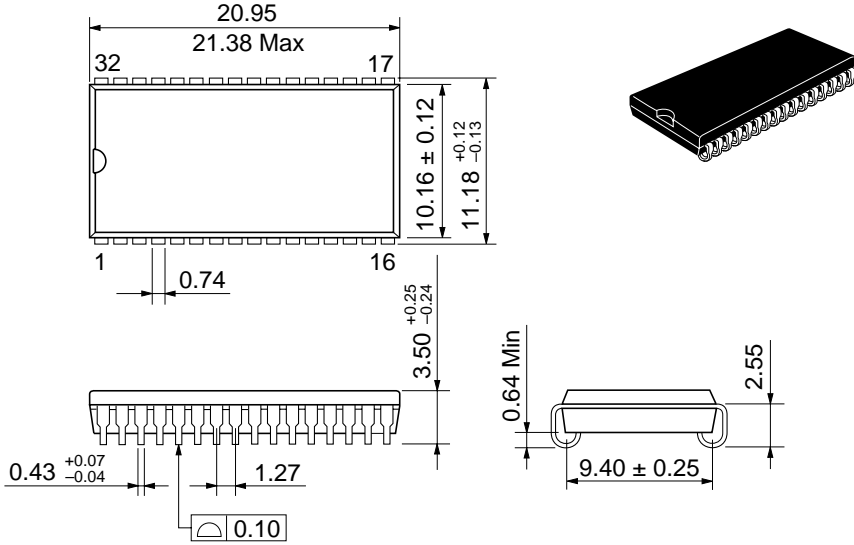
HM5164805A Series, HM5165805A Series

Package Dimensions

HM5164805AJ/ ALJ Series

HM5165805AJ/ ALJ Series (CP-32DC)

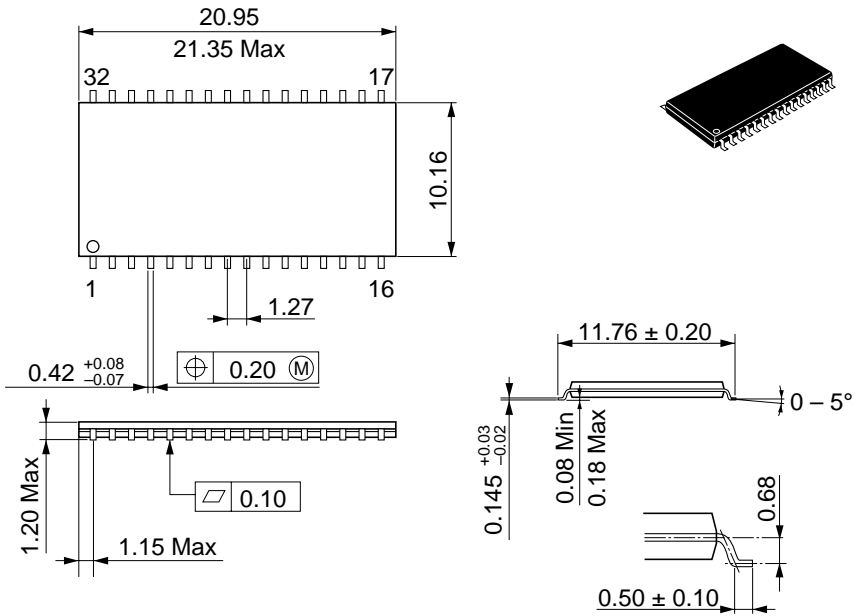
Unit: mm



HM5164805ATT/ALTT Series

HM5165805ATT/ALTT Series (TTP-32DC)

Unit: mm



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Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
0.0	Oct. 13, 1995	Initial issue	S. Ikenaga	J. Kitano
0.1	Apr. 30, 1996	Change format Unification of HM5164805A Series and HM5165805A Series Addition of HM5164805A/HM5165805A-5 Series Addition of HM5164805AJ/ALJ Series, HM5165805AJ/ALJ Series (CP-32DC) Pin Descriptions Addition of Row/Refresh address and Column address to address input Addition of Block Diagrams DC Characteristics (HM5164805A) I _{CC1} max: 105/95 mA to TBD/135/115 mA I _{CC3} max: 105/95 mA to TBD/135/115 mA I _{CC6} max: 105/95 mA to TBD/150/130 mA I _{CC7} max: 105/95 mA to TBD/145/125 mA Addition of note 4 DC Characteristics (HM5165805A) I _{CC1} max: 145/135 mA to TBD/185/165 mA I _{CC3} max: 125/110 mA to TBD/185/165 mA I _{CC6} max: 125/110 mA to TBD/150/130 mA I _{CC7} max: 125/110 mA to TBD/145/125 mA Addition of note 4 AC Characteristics t _{RCD} max: 38/45 ns to TBD/45/52 ns t _{COP} min: 5/5 ns to TBD/10/10 ns Addition of t _{WPE} and t _{OEP} t _{HPRWC} min: 79/90 ns to TBD/68/79 ns Addition of notes 20 to 24 Change of notes 3 and 13 Timing waveforms Addition of t _{WPE} and t _{OEP} timings Deletion of note: t _{OEH} ≥ t _{CWL}	S. Ikenaga	J. Kitano
0.2	Jun. 12, 1996	AC Characteristics Change of notes 18 and 25 Timing waveforms Deletion of notes about undefined pins		